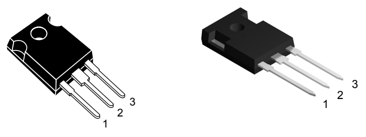
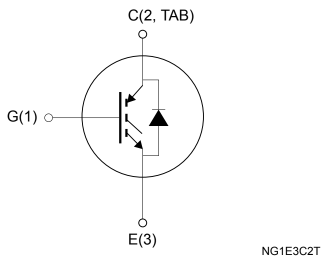
STGW8M120DF3, STGWA8M120DF3

Datasheet

Trench gate field-stop 1200 V, 8 A low-loss M series IGBT in a TO-247 and TO-247 long leads packages





Product status links
STGW8M120DF3
STGWA8M120DF3

Product summary	
Order code	**STGW8M120DF3**
Marking	G8M120DF3
Package	TO-247
Packing	Tube
Order code	**STGWA8M120DF3**
Marking	G8M120DF3
Package	TO-247 long leads
Packing	Tube

Features

- Maximum junction temperature: T_J = 175 °C
- 10 µs of minimum short-circuit withstand time
- $V_{CE(sat)}$ = 1.85 V (typ.) @ I_C = 8 A
- Tight parameter distribution
- Safer paralleling
- Positive $V_{CE(sat)}$ temperature coefficient
- Low thermal resistance
- Soft and very fast-recovery antiparallel diode

Applications

- Industrial drives
- Uninterruptable power supplies (UPS)
- Solar inverters
- Welding

Description

These devices are IGBTs developed using an advanced proprietary trench gate field-stop structure. The devices are part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where the low-loss and the short-circuit functionality are essential. Furthermore, the positive $V_{CE(sat)}$ temperature coefficient and the tight parameter distribution result in safer paralleling operation.

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage (V_{GE} = 0 V)	1200	V
I_C	Continuous collector current at T_C = 25 °C	16	A
	Continuous collector current at T_C = 100 °C	8	A
I_{CP} (1)	Pulsed collector current	32	A
V_{GE}	Gate-emitter voltage	±20	V
I_F	Continuous forward current at T_C = 25 °C	16	A
I_F	Continuous forward current at T_C = 100 °C	8	A
I_{FP} (1)	Pulsed forward current	32	A
P_{TOT}	Total power dissipation at T_C = 25 °C	167	W
T_{STG}	Storage temperature range	-55 to 150	°C
T_J	Operating junction temperature range	-55 to 175	°C

1. *Pulse width limited by maximum junction temperature.*

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance, junction-to-case IGBT	0.9	°C/W
	Thermal resistance, junction-to-case diode	1.47	°C/W
R_{thJA}	Thermal resistance, junction-to-ambient	50	°C/W

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 3. Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	V_{GE} = 0 V, I_C = 2 mA	1200			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	V_{GE} = 15 V, I_C = 8 A		1.85	2.3	V
		V_{GE} = 15 V, I_C = 8 A, T_J = 125 °C		2.1		
		V_{GE} = 15 V, I_C = 8 A, T_J = 175 °C		2.2		
V_F	Forward on-voltage	I_F = 8 A		2.4	3.35	V
		I_F = 8 A, T_J = 125 °C		1.75		
		I_F = 8 A, T_J = 175 °C		1.55		
$V_{GE(th)}$	Gate threshold voltage	V_{CE} = V_{GE}, I_C = 500 µA	5	6	7	V
I_{CES}	Collector cut-off current	V_{GE} = 0 V, V_{CE} = 1200 V			25	µA
I_{GES}	Gate-emitter leakage current	V_{GE} = ±20 V, V_{CE} = 0 V			±250	nA

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies}	Input capacitance	V_{CE} = 25 V, f = 1 MHz, V_{GE} = 0 V	-	542	-	pF
C_{oes}	Output capacitance		-	74.4	-	
C_{res}	Reverse transfer capacitance		-	21	-	
Q_g	Total gate charge	V_{CC} = 960 V, I_C = 8 A, V_{GE} = 0 to 15 V (see Figure 29)	-	32	-	nC
Q_{ge}	Gate-emitter charge		-	4.5	-	
Q_{gc}	Gate-collector charge		-	18.5	-	

Table 5. IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	V_{CE} = 600 V, I_C = 8 A, V_{GE} = 15 V, R_G = 33 Ω (see Figure 28)		20	-	ns
t_r	Current rise time			8.4	-	ns
$(di/dt)_{on}$	Turn-on current slope			800	-	A/μs
$t_{d(off)}$	Turn-off-delay time			126	-	ns
t_f	Current fall time			136	-	ns
E_{on} (1)	Turn-on switching energy			0.39	-	mJ
E_{off} (2)	Turn-off switching energy			0.37	-	mJ
E_{ts}	Total switching energy			0.76	-	mJ
$t_{d(on)}$	Turn-on delay time	V_{CE} = 600 V, I_C = 8 A, V_{GE} = 15 V, R_G = 33 Ω, T_J = 175 °C (see Figure 28)		19	-	ns
t_r	Current rise time			9.8	-	ns
$(di/dt)_{on}$	Turn-on current slope			656	-	A/μs
$t_{d(off)}$	Turn-off-delay time			134	-	ns
t_f	Current fall time			222	-	ns
E_{on} (1)	Turn-on switching energy			0.66	-	mJ
E_{off} (2)	Turn-off switching energy			0.58	-	mJ
E_{ts}	Total switching energy			1.24	-	mJ
t_{sc}	Short-circuit withstand time	$V_{CC} \leq$ 600 V, V_{GE} = 15 V, $T_{Jstart} \leq$ 150 °C	10		-	μs

1. *Including the reverse recovery of the diode*
2. *Including the tail of the collector current*

Table 6. Diode switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t_{rr}	Reverse recovery time	I_F = 8 A, V_R = 600 V, V_{GE} = 15 V, R_G = 33 Ω (di/dt = 1000 A/μs) (see Figure 28)	-	103	-	ns
Q_{rr}	Reverse recovery charge		-	0.87	-	μC
I_{rrm}	Reverse recovery current		-	19.2	-	A
dI_{rr}/dt	Peak rate of fall of reverse recovery current during t_b		-	720	-	A/μs
E_{rr}	Reverse recovery energy		-	211	-	μJ
t_{rr}	Reverse recovery time	I_F = 8 A, V_R = 600 V, V_{GE} = 15 V, T_J = 175 °C, R_G = 33 Ω (di/dt = 840 A/μs), (see Figure 28)	-	280	-	ns
Q_{rr}	Reverse recovery charge		-	1.9	-	μC
I_{rrm}	Reverse recovery current		-	21.8	-	A
dI_{rr}/dt	Peak rate of fall of reverse recovery current during t_b		-	450	-	A/μs
E_{rr}	Reverse recovery energy		-	404	-	μJ

2.1 Electrical characteristics (curves)

Figure 1. Power dissipation vs case temperature

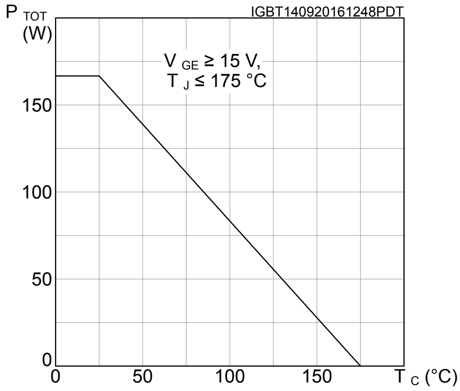


Figure 2. Collector current vs case temperature

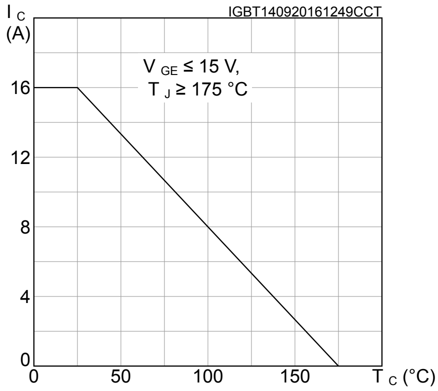


Figure 3. Output characteristics (T_J = 25 °C)

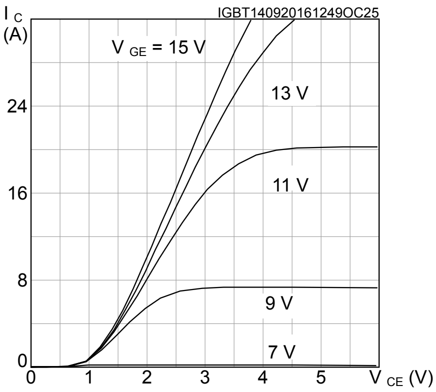


Figure 4. Output characteristics (T_J = 175 °C)

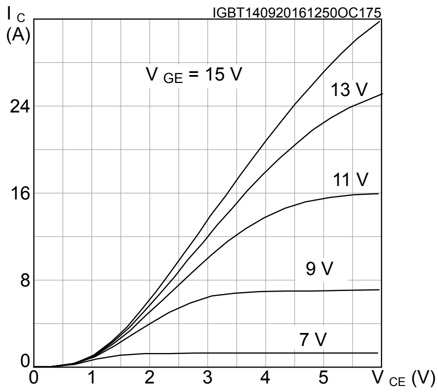


Figure 5. $V_{CE(sat)}$ vs junction temperature

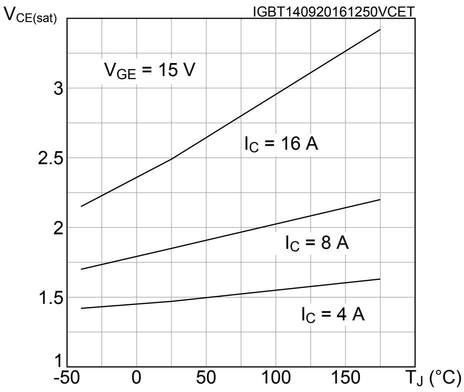


Figure 6. $V_{CE(sat)}$ vs collector current

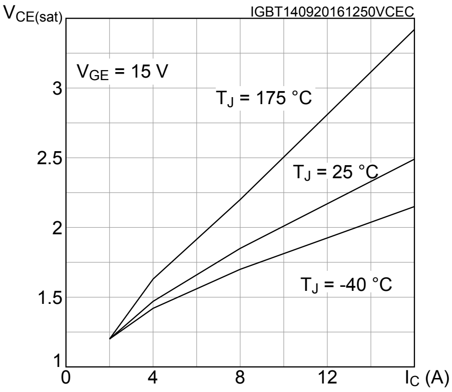


Figure 7. Collector current vs switching frequency

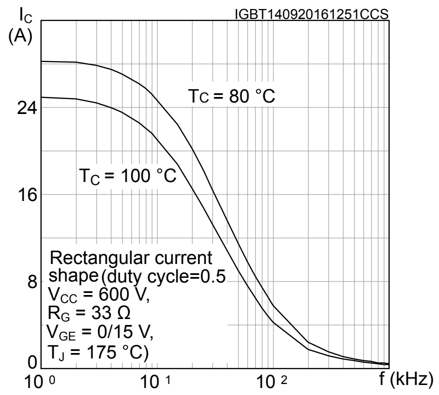


Figure 8. Forward bias safe operating area

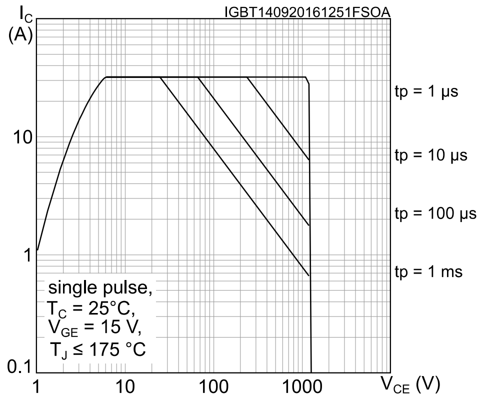


Figure 9. Transfer characteristics

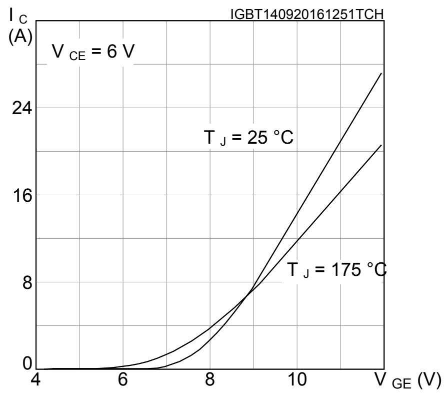


Figure 10. Diode V_F vs forward current

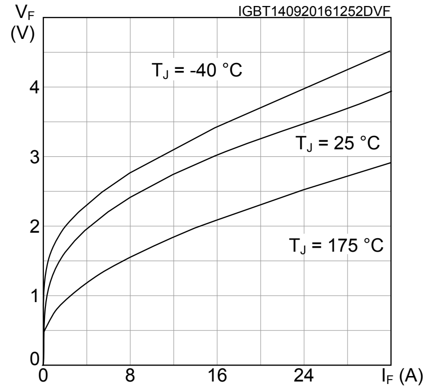


Figure 11. Normalized $V_{GE(th)}$ vs junction temperature

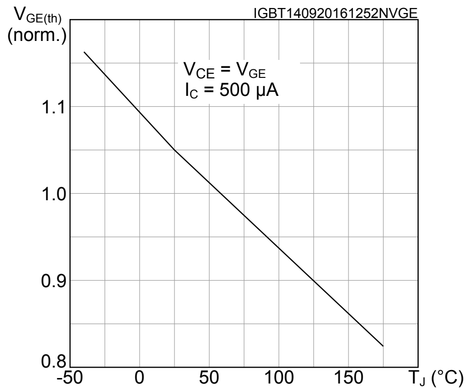


Figure 12. Normalized $V_{(BR)CES}$ vs junction temperature

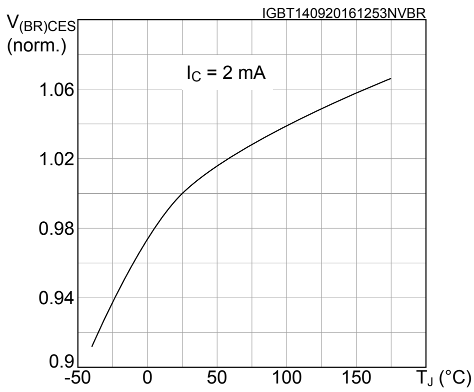


Figure 13. Capacitance variations

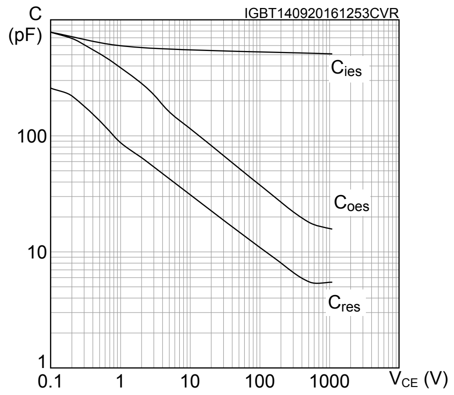


Figure 14. Gate charge vs gate-emitter voltage

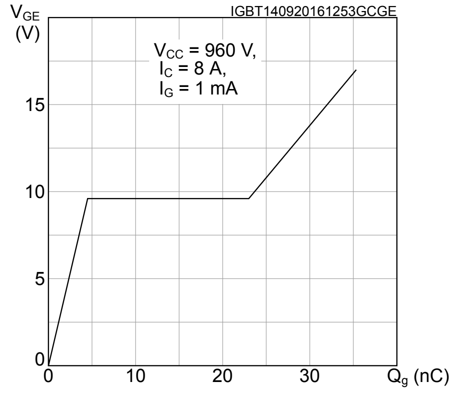


Figure 15. Switching energy vs collector current

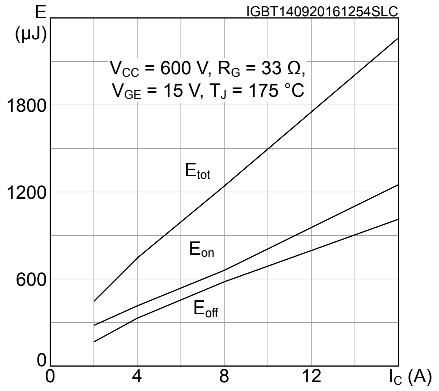


Figure 16. Switching energy vs gate resistance

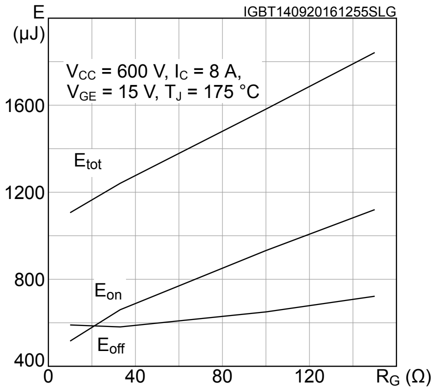


Figure 17. Switching energy vs temperature

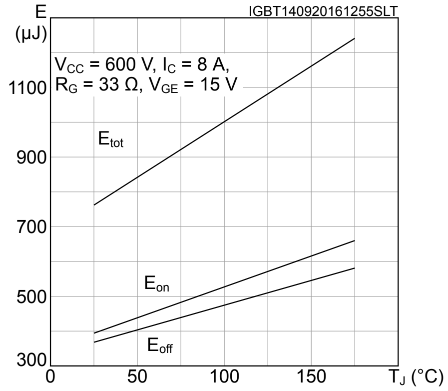


Figure 18. Switching energy vs collector emitter voltage

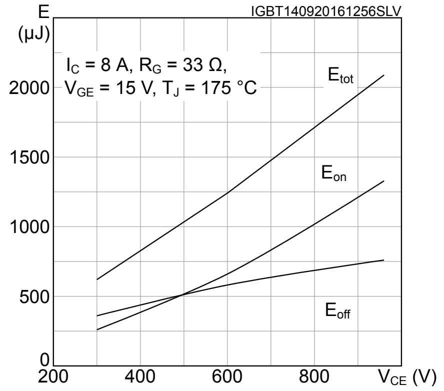


Figure 19. Short-circuit time and current vs V_{GE}

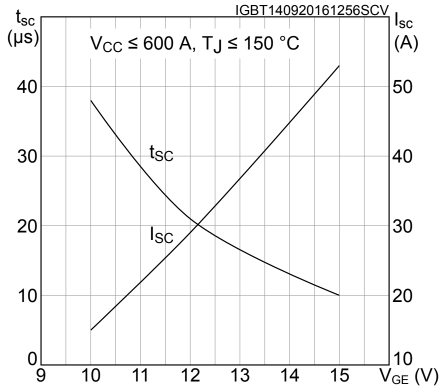


Figure 20. Switching times vs collector current

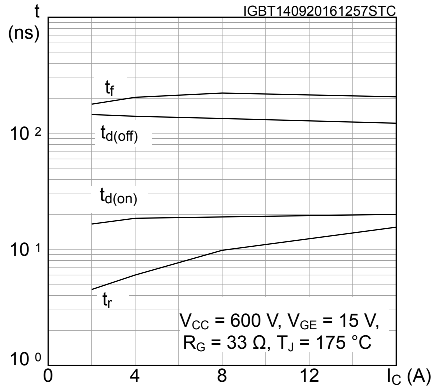


Figure 21. Switching times vs gate resistance

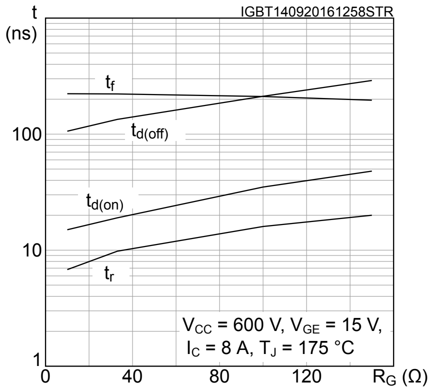


Figure 22. Reverse recovery current vs diode current slope

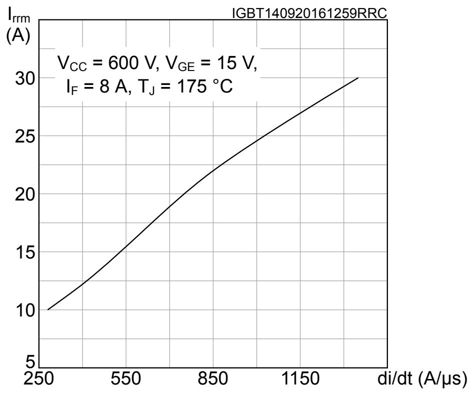


Figure 23. Reverse recovery time vs diode current slope

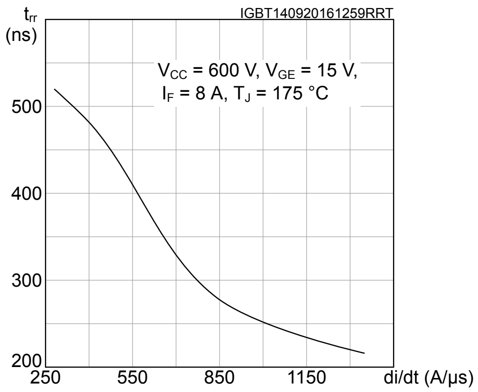
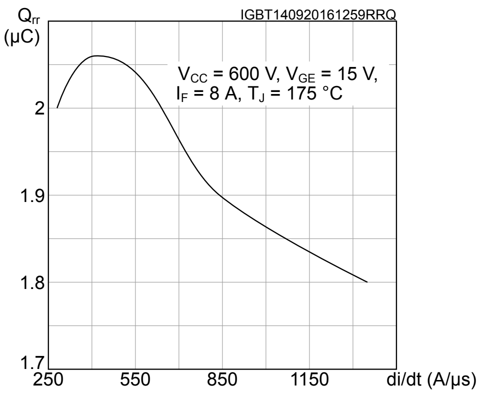


Figure 24. Reverse recovery charge vs diode current slope



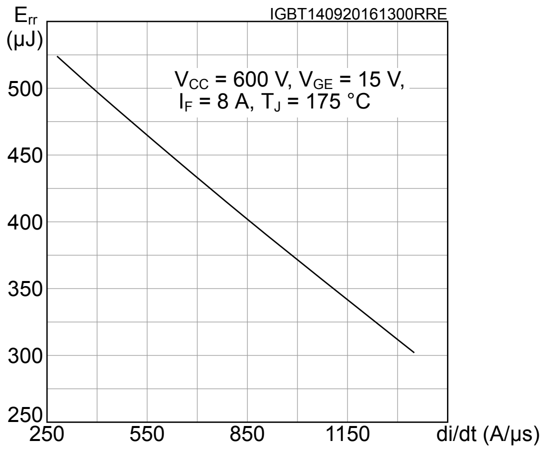


Figure 25. Reverse recovery energy vs diode current slope

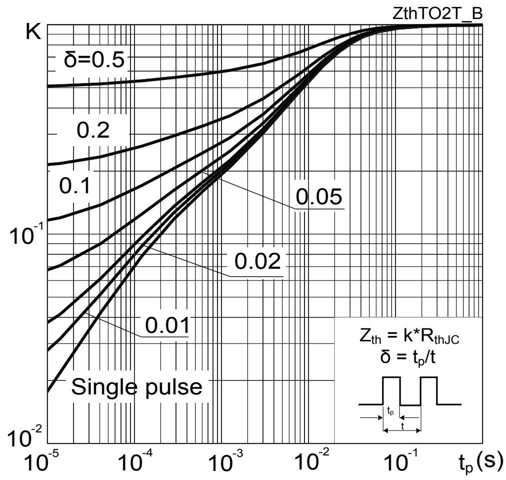


Figure 26. Thermal impedance for IGBT

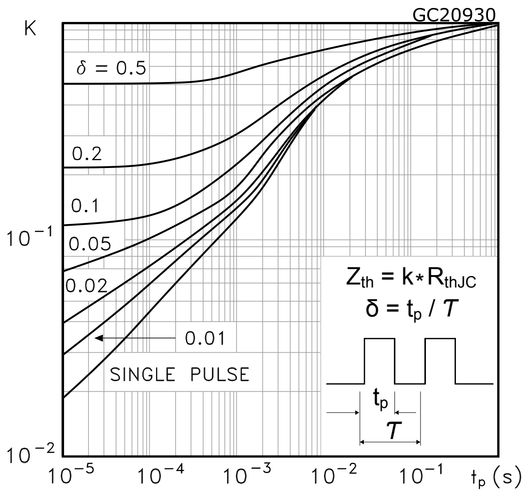


Figure 27. Thermal impedance for diode

3 Test circuits

Figure 28. Test circuit for inductive load switching

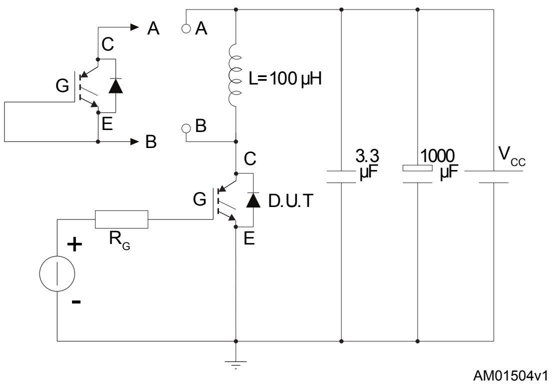


Figure 29. Gate charge test circuit

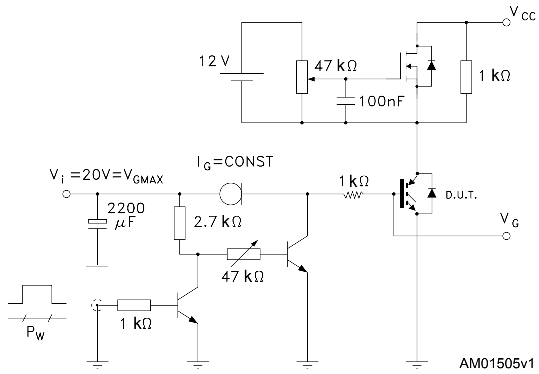


Figure 30. Switching waveform

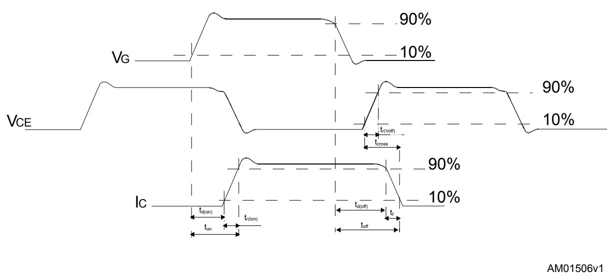
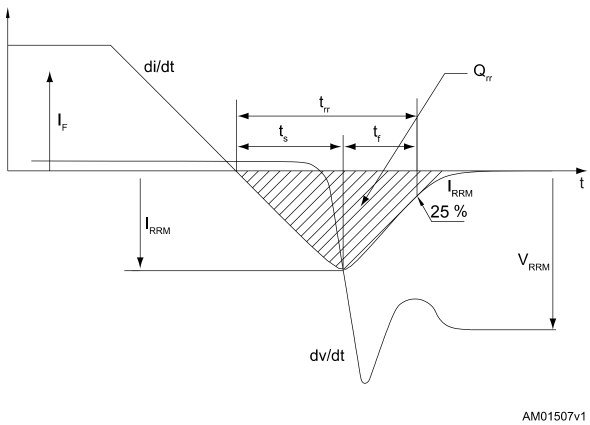


Figure 31. Diode reverse recovery waveform



4 Package information

To meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions, and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 TO-247 package information

Figure 32. TO-247 package outline

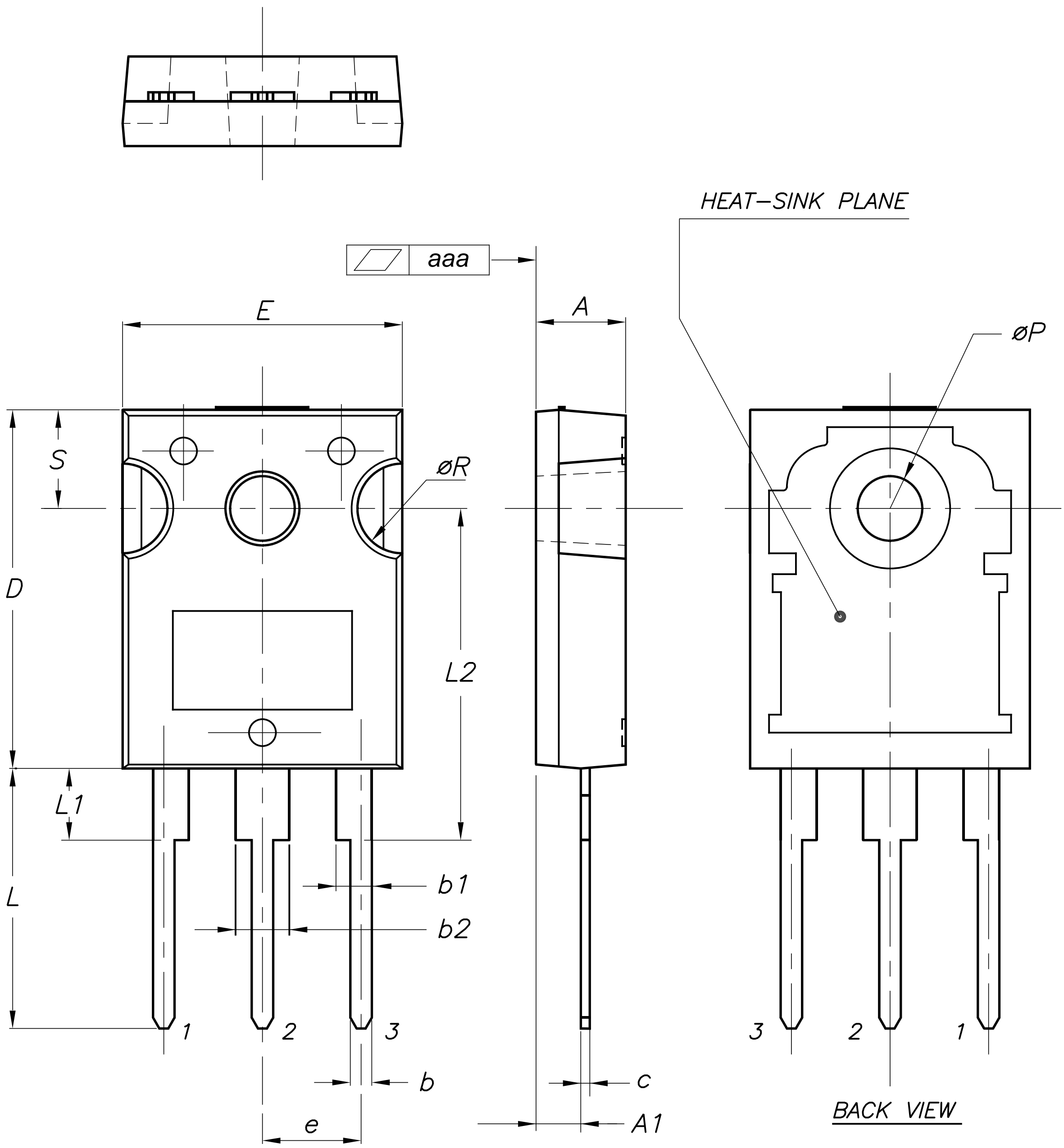


Table 7. TO-247 package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70
aaa		0.04	0.10

4.2 TO-247 long leads package information

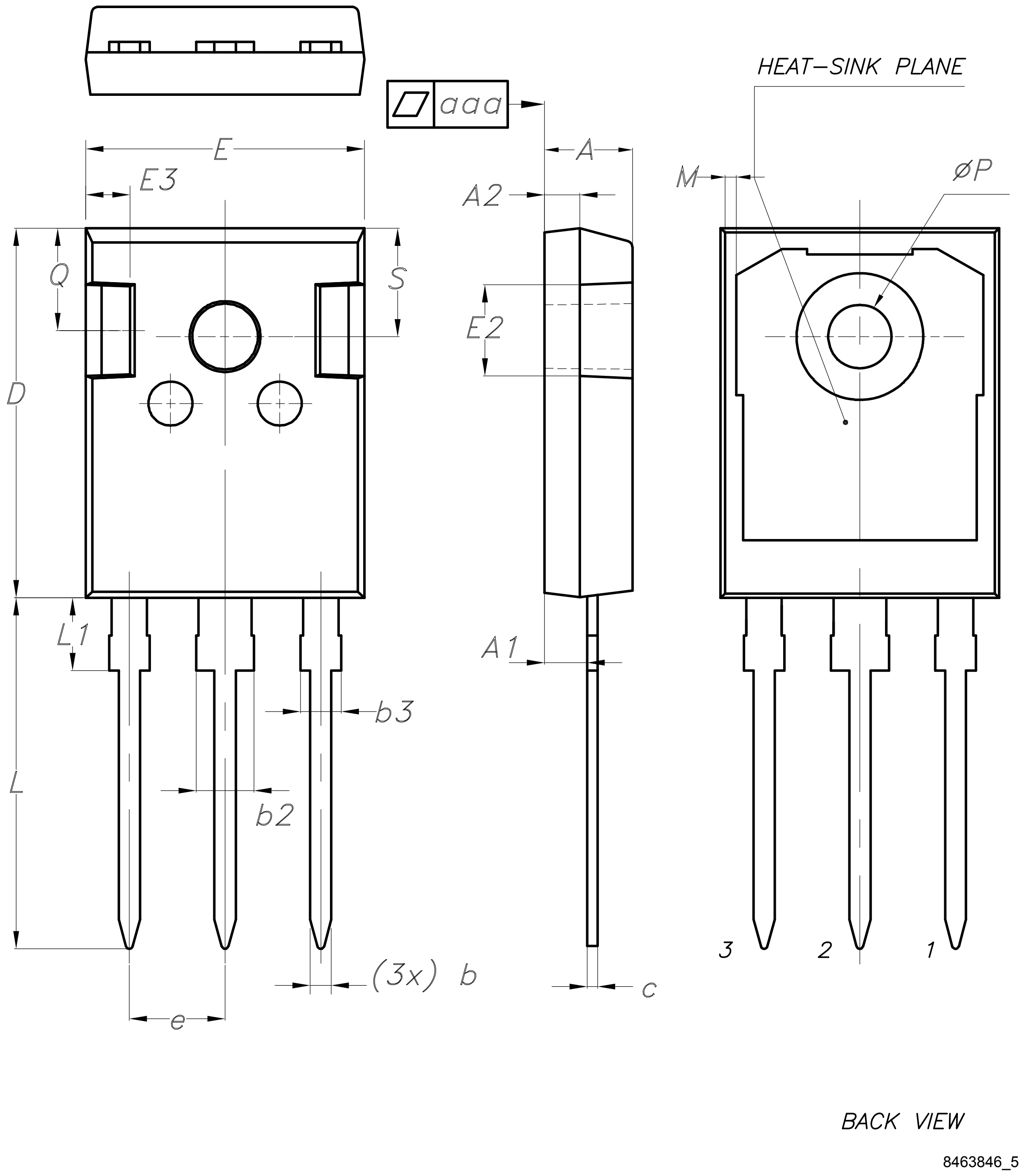


Figure 33. TO-247 long leads package outline

Table 8. **TO-247 long leads package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
c	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
M	0.35		0.95
P	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25
aaa		0.04	0.10

Revision history

Table 9. Document revision history

Date	Revision	Changes
11-May-2016	1	First release.
19-Sep-2016	2	Datasheet promoted from preliminary to production data. Updated *Table 2: "Absolute maximum ratings"*. Updated *Section 2: "Electrical characteristics"*. Added *Section 2.1: "Electrical characteristics (curves)"*.
24-Oct-2017	3	Updated package silhouette on cover page. Updated *Table 4: "Static characteristics"* and *Table 5: "Dynamic characteristics"*. Minor text changes
12-Feb-2025	4	Updated title in cover page. Updated Section 4.1: TO-247 package information, and Section 4.2: TO-247 long leads package information. Minor text changes.

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